

10033854-052FSLF : DDR2
SODIMM reverse type, 200pos,
0.6mm pitch, locating peg, Au
flash on terminal contact and
solder tail

ACTIVE



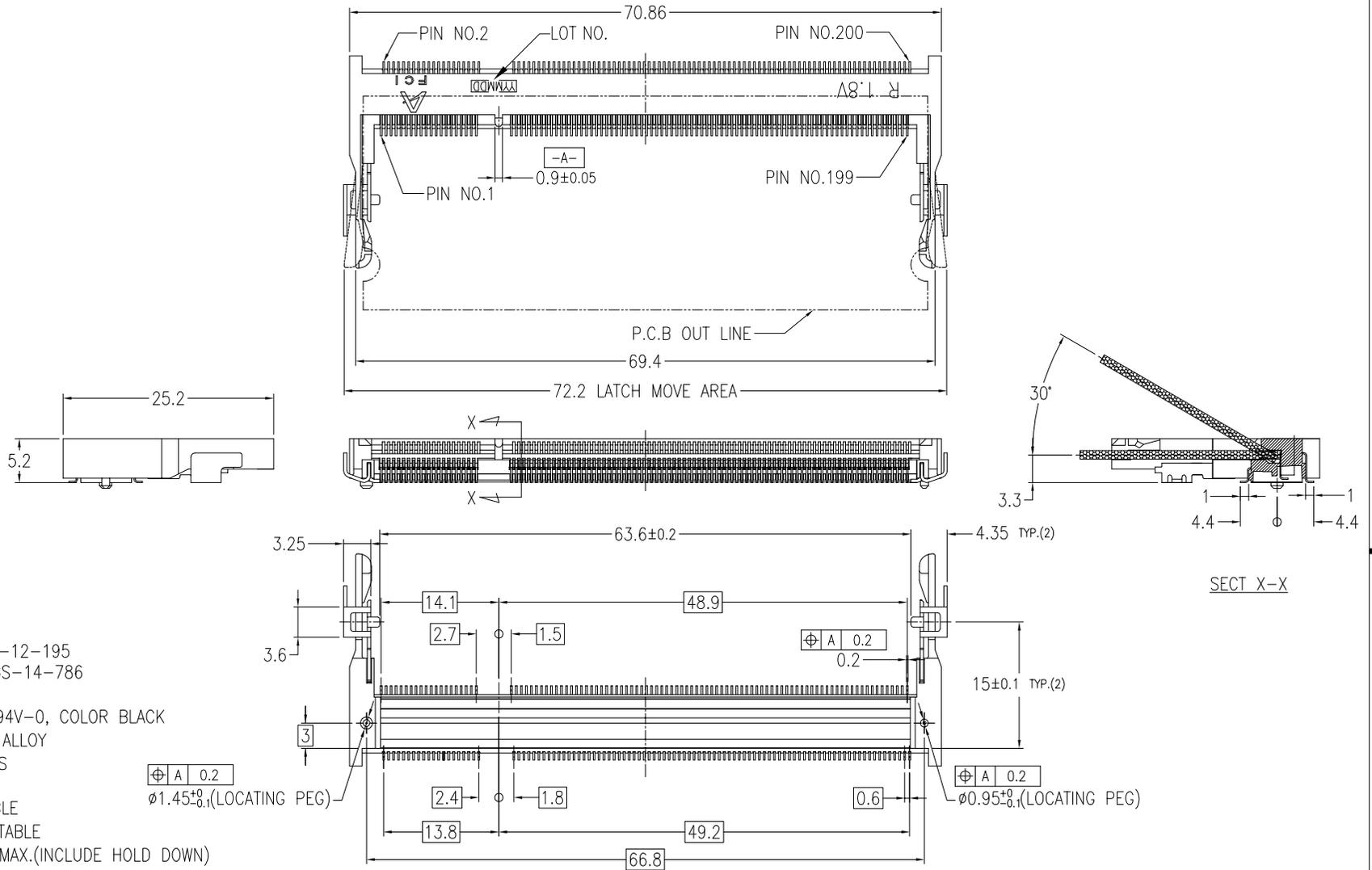
www.fci.com

Comments

The P/N is available however it is not a promoted item, we advise you to contact our customer service for further information in case of existing standard alternative product.



PRODUCT NO.
10033854-*52**



NOTE

1. PRODUCT SPEC. : GS-12-195
2. PACKAGING SPEC. : GS-14-786
3. MATERIAL
 - 1) HOUSING : LCP, UL94V-0, COLOR BLACK
 - 2) CONTACT : COPPER ALLOY
 - 3) HOLD DOWN : BRASS
4. FINISH
 - 1) TERMINAL : SEE TABLE
 - 2) HOLD DOWN : SEE TABLE
5. CO-PLANARITY : 0.1 MAX.(INCLUDE HOLD DOWN)
6. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
7. THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A REFLOW SOLDER APPLICATION.

⊕ A 0.2

∅1.45^{+0.01}(LOCATING PEG)

⊕ A 0.2

0.2

⊕ A 0.2

∅0.95^{+0.01}(LOCATING PEG)

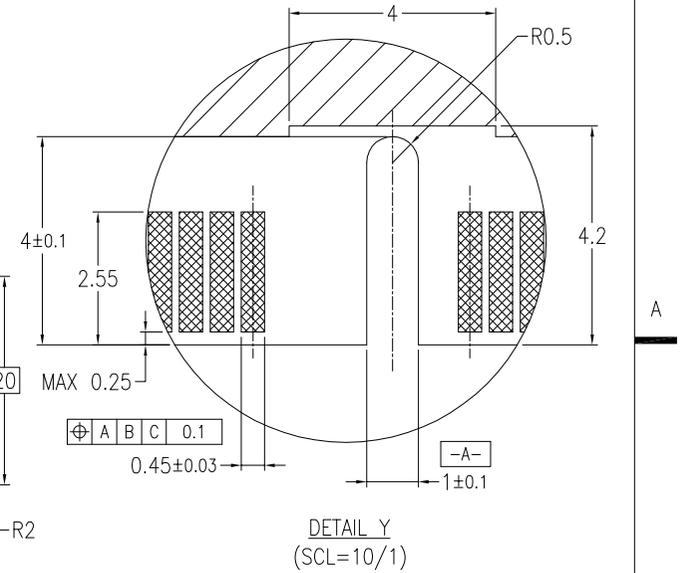
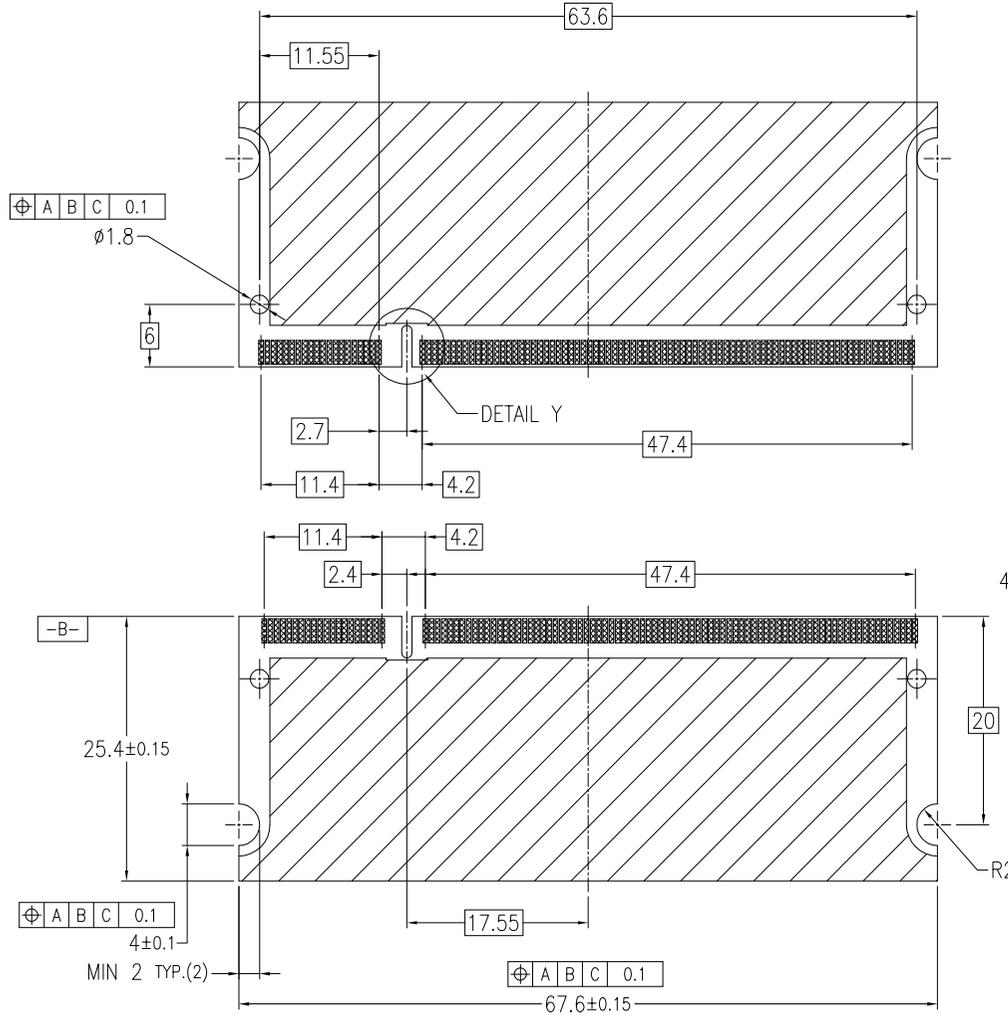
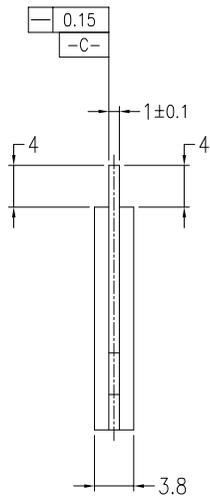
mat'l. code				tolerances unless otherwise specified			CUSTOMER COPY	 www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.20		projection	title	
2		M H	8/28/'03		.XX ± 0.10			DDR II 0.6 mm PITCH 200 POS. REVERSE TYPE ASS'Y	
3		M H	4/2/'04		0° ± 5°			product family 50UF SO-DIMM	
4		M H	6/29/'04					size dwg no	
A	J04-0401	M H	9/28/'04	dr	M.Hasegawa	6/29/'04	scale	code	
B	T05-0022	R C	11/9/'04	enr	M.Hasegawa	6/29/'04		JP	
C	T05-0229	R C	10/12/'05	chr				sheet	
D	pc08-0333	B L	12/1/'08	appd				1 of 4	
sheet	revision	D	D	D	D		2:1		
index	sheet	1	2	3	4				

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PRODUCT NO.
10033854-*52**



RECOMMENDED MODULE P.C.B LAYOUT

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY		 www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.20	projection		title	
D					.XX ± 0.10			DDR II 0.6 mm PITCH 200 POS. REVERSE TYPE ASS'Y	
				angles	0° ± 5°	 MM	scale	product family	code
				dr	M.Hasegawa 6/29/04			50UF SO-DIMM	JP
				enr	M.Hasegawa 6/29/04			size	dwg no
				chr		2:1		B	10033854
				appd				sheet	3 of
sheet index	revision sheet								

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PRODUCT NO.	LOCATING PEG	TERMINAL CONTACT AREA FINISH	HOLD DOWN FINISH	SOLDER TAIL FINISH
10033854-052FSLF	YES	Au FLASH	PURE Sn PLATING	Au FLASH
10033854-152FSLF	NO			
10033854-052TSLF	YES	Au 0.3um MIN.		
10033854-152TSLF	NO			
10033854-052ASLF	YES	Au 0.76um MIN.		
10033854-152ASLF	NO			
10033854-052FB	YES	Au FLASH	Sn-Pb PLATING	
10033854-152FB	NO			
10033854-052TB	YES	Au 0.3um MIN.		
10033854-152TB	NO			
10033854-052AB	YES	Au 0.76um MIN.		
10033853-152AB	NO			
10033854-252FSLF	YES	Au FLASH	PURE Sn PLATING	Pure Sn PLATING
10033854-352FSLF	NO			
10033854-252TSLF	YES	Au 0.3um MIN.		
10033854-352TSLF	NO			
10033854-252ASLF	YES	Au 0.76um MIN.		
10033854-352ASLF	NO			
10033854-252FB	YES	Au FLASH	Sn-Pb PLATING	
10033854-352FB	NO			
10033854-252TB	YES	Au 0.3um MIN.		
10033854-352TB	NO			
10033854-252AB	YES	Au 0.76um MIN.		
10033854-352AB	NO			
10033854-452FS	YES	Au FLASH	PURE Sn PLATING	Sn-Pb PLATING
10033854-552FS	NO			
10033854-452TS	YES	Au 0.3um MIN.		
10033854-552TS	NO			
10033854-452AS	YES	Au 0.76um MIN.		
10033854-552AS	NO			
10033854-452FB	YES	Au FLASH	Sn-Pb PLATING	
10033854-552FB	NO			
10033854-452TB	YES	Au 0.3um MIN.		
10033854-552TB	NO			
10033854-452AB	YES	Au 0.76um MIN.		
10033854-552AB	NO			

10033854-□□□□□ LF

<PACKING METHOD>
R : TAPE REEL
DEFAULT : TRAY

<HOLD DOWN FINISH>
S : Pure Sn
B : Sn-Pb

<CONTACT AREA FINISH>
F : Au FLASH
T : Au 0.3um MIN.
A : Au 0.76um MIN.

<TOTAL HEIGHT>
52 : 5.2mm

<LOCATING PEG, SOLDER TAIL FINISH>
0 : YES, Au FLASH
1 : NO, Au FLASH
2 : YES, Pure Sn PLATING
3 : NO, Pure Sn PLATING
4 : YES, Sn-Pb PLATING
5 : NO, Sn-Pb PLATING

For Rohs OPTIONS:
TAIL PLATING CODE MUST BE 0~3.
HOLD DOWN PLATING CODE MUST BE "S".
"LF" CODE IS EXIST IN THE END.
EX: 10033854-252TSLF

FOR NOT Rohs COMPATIBLE:
THIS "LF" CODE IS "BLANK".
EX:10033854-452TS

mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY		 www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.20	projection		title	
D					.XX ± 0.10			DDR II 0.6 mm PITCH 200 POS. REVERSE TYPE ASS'Y	
				angles	0° ± 5°	 MM	 scale	product family	code
				dr	M.Hasegawa 6/29/04			50UF SO-DIMM	JP
				enrg	M.Hasegawa 6/29/04	2:1	B	size	sheet
				chr				10033854	4 of
sheet index	revision sheet								